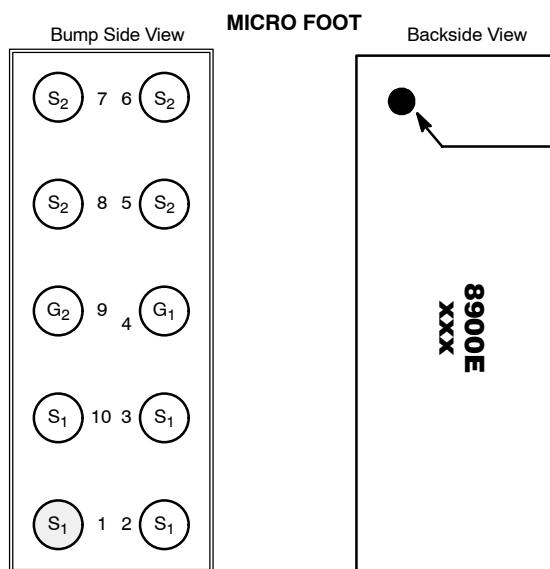


## Bi-Directional N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY		
$V_{S1S2}$ (V)	$r_{S1S2(on)}$ ( $\Omega$ )	$I_{S1S2}$ (A)
20	0.024 @ $V_{GS} = 4.5$ V	7
	0.026 @ $V_{GS} = 3.7$ V	6.8
	0.034 @ $V_{GS} = 2.5$ V	5.0
	0.040 @ $V_{GS} = 1.8$ V	5.5

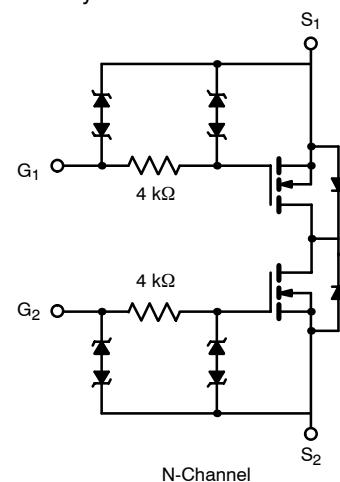


### FEATURES

- TrenchFET® Power MOSFET
- Ultra-Low  $r_{SS(on)}$
- ESD Protected: 4000 V
- New MICRO FOOT® Chipscale Packaging Reduces Footprint Area Profile (0.62 mm) and On-Resistance Per Footprint Area

### APPLICATIONS

- Battery Protection Circuit
  - 1-2 Cell Li+/LiP Battery Pack for Portable Devices



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)					
Parameter		Symbol	5 secs	Steady State	Unit
Source1—Source2 Voltage		$V_{S1S2}$		20	V
Gate-Source Voltage		$V_{GS}$		$\pm 12$	
Continuous Source1—Source2 Current ( $T_J = 150^\circ\text{C}$ ) <sup>a</sup>		$I_{S1S2}$	7	5.4	A
$T_A = 25^\circ\text{C}$			5.1	3.9	
Pulsed Source1—Source2 Current		$I_{SM}$		50	
Maximum Power Dissipation <sup>a</sup>		$P_D$	1.8	1	W
$T_A = 85^\circ\text{C}$			0.9	0.5	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$		-55 to 150	°C
Package Reflow Conditions <sup>c</sup>		VPR IR/Convection		215 220	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$t \leq 5$ sec	$R_{thJA}$	55	70	°C/W
	Steady State		95	120	
Maximum Junction-to-Foot <sup>b</sup>	Steady State	$R_{thJF}$	12	15	

#### Notes

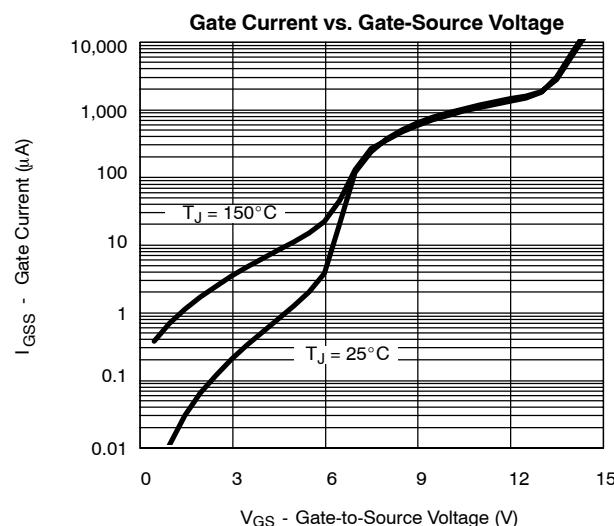
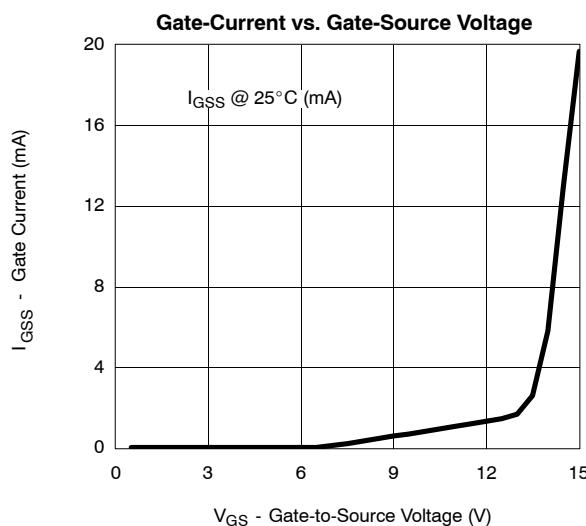
- Surface Mounted on 1" x 1" FR4 Board.
- The Foot is defined as the top surface of the package.
- Refer to IPC/JEDEC (J-STD-020A), no manual or hand soldering.

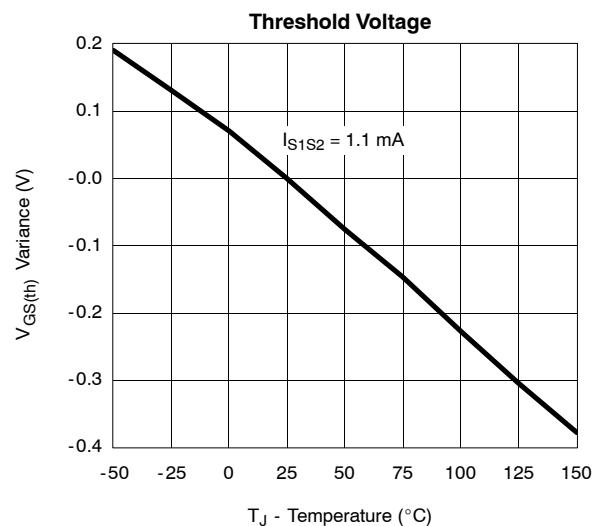
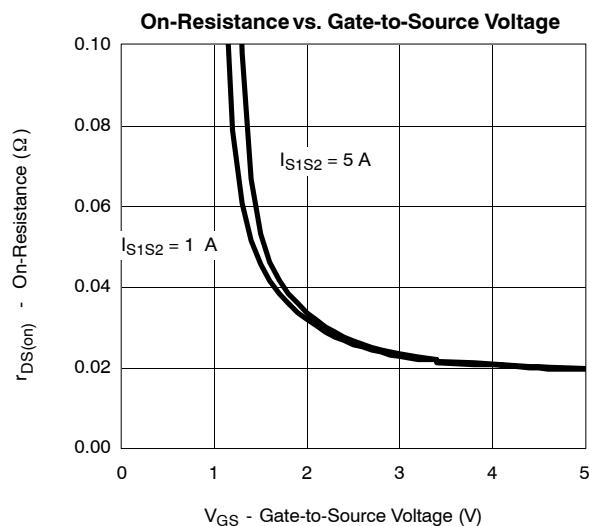
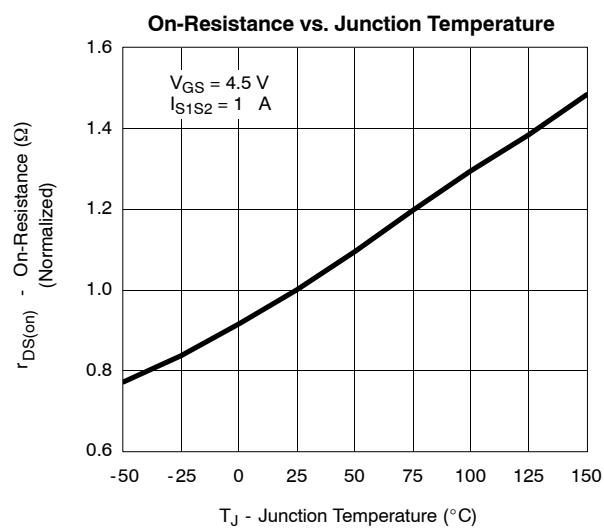
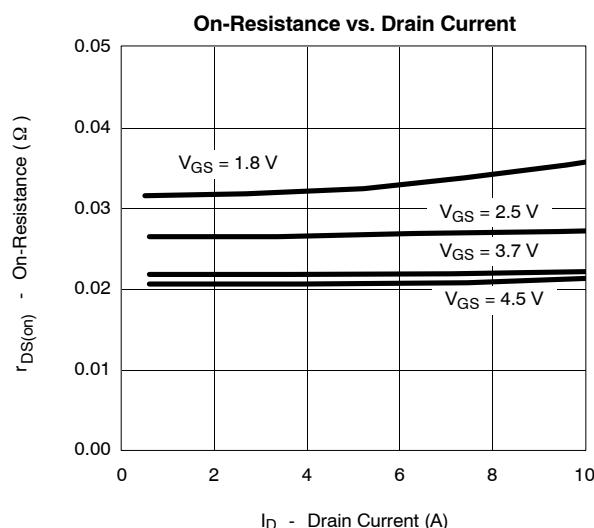
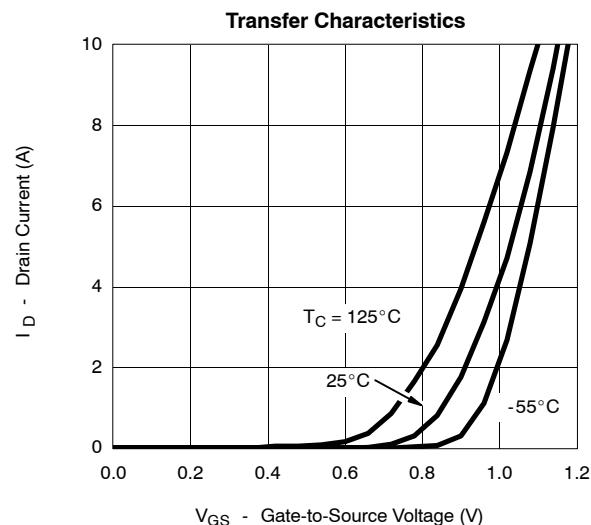
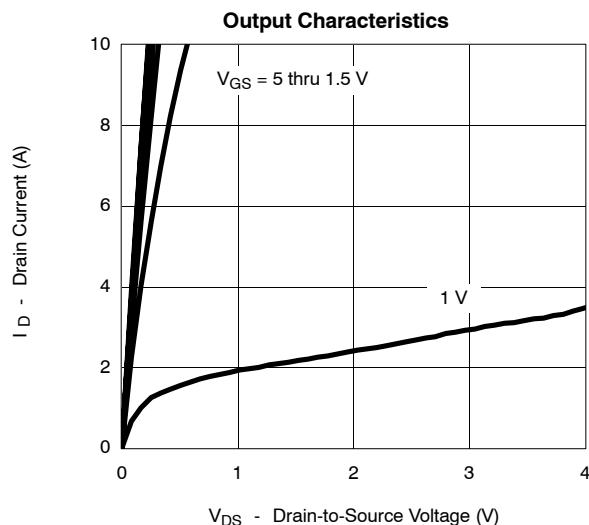
**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

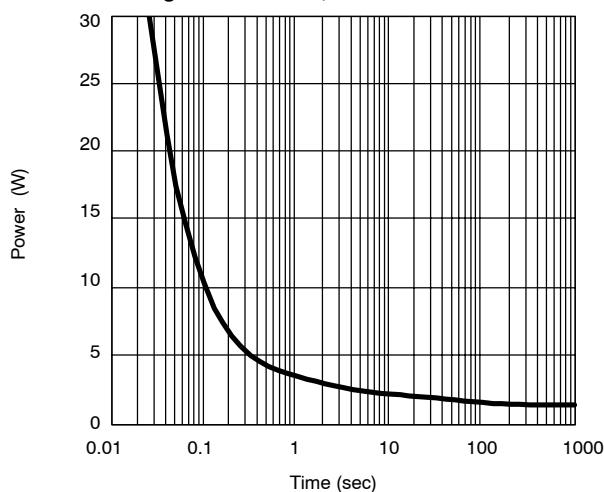
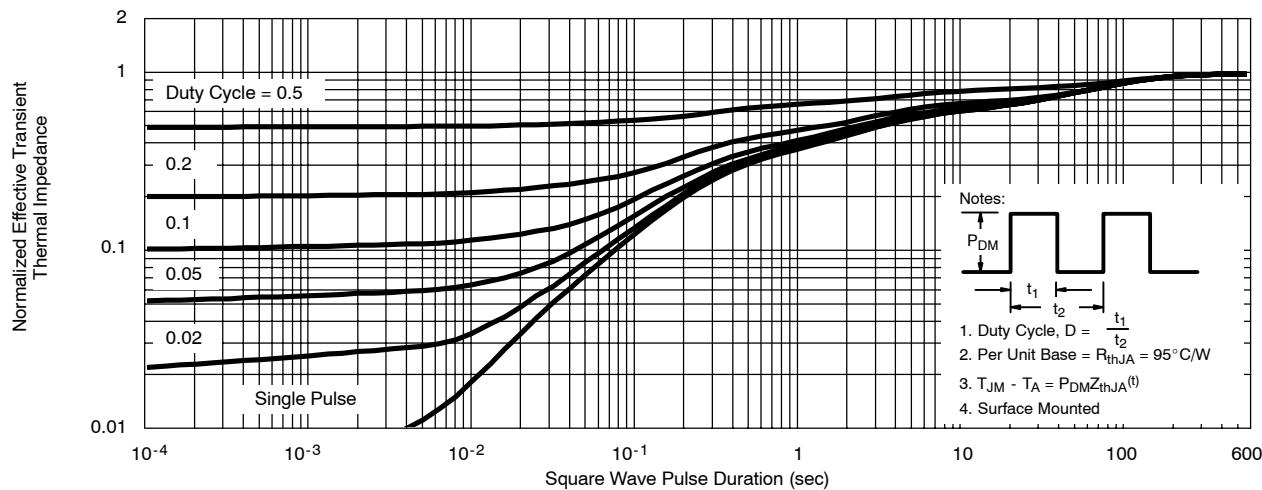
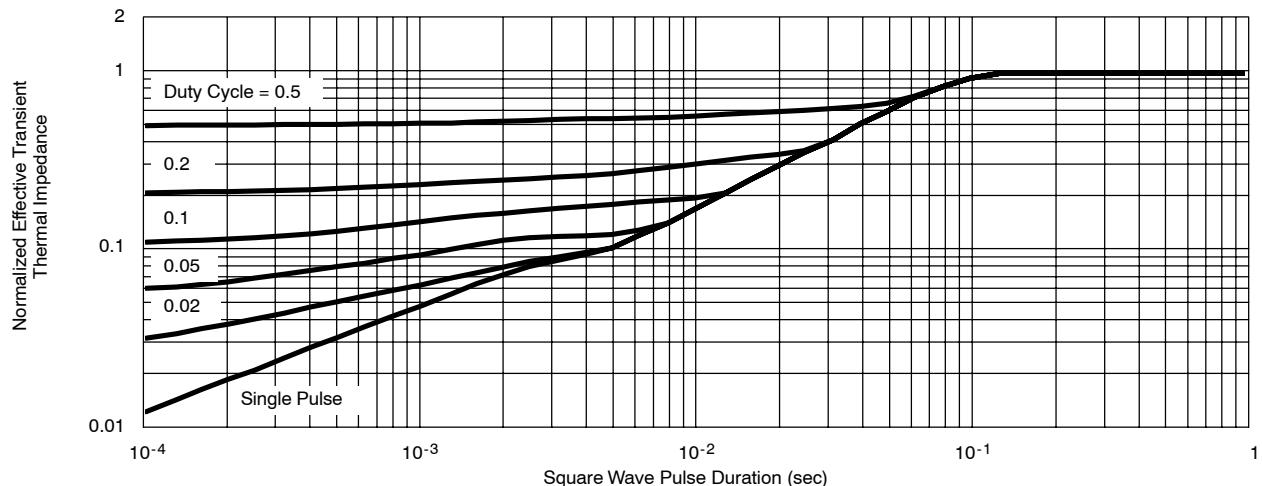
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{SS} = V_{GS}, I_D = 1.1 \text{ mA}$	0.45		1.0	V
Gate-Body Leakage	$I_{GSS}$	$V_{SS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			$\pm 4$	$\mu\text{A}$
		$V_{SS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			$\pm 10$	mA
Zero Gate Voltage Source Current	$I_{S1S2}$	$V_{SS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$		1		$\mu\text{A}$
		$V_{SS} = 16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85^\circ\text{C}$		5		
On-State Source Current <sup>a</sup>	$I_{S(\text{on})}$	$V_{SS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	5			A
Source1—Source2 On-State Resistance <sup>a</sup>	$r_{S1S2(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_{SS} = 1 \text{ A}$		0.020	0.024	$\Omega$
		$V_{GS} = 3.7 \text{ V}, I_{SS} = 1 \text{ A}$		0.022	0.026	
		$V_{GS} = 2.5 \text{ V}, I_{SS} = 1 \text{ A}$		0.026	0.034	
		$V_{GS} = 1.8 \text{ V}, I_{SS} = 1 \text{ A}$		0.032	0.040	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{SS} = 10 \text{ V}, I_{SS} = 1 \text{ A}$		31		S
<b>Dynamic<sup>b</sup></b>						
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{SS} = 10 \text{ V}, R_L = 10 \Omega$ $I_{SS} \equiv 1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 6 \Omega$		3	5	$\mu\text{s}$
Rise Time	$t_r$			4.5	7	
Turn-Off Delay Time	$t_{d(\text{off})}$			55	85	
Fall Time	$t_f$			15	25	

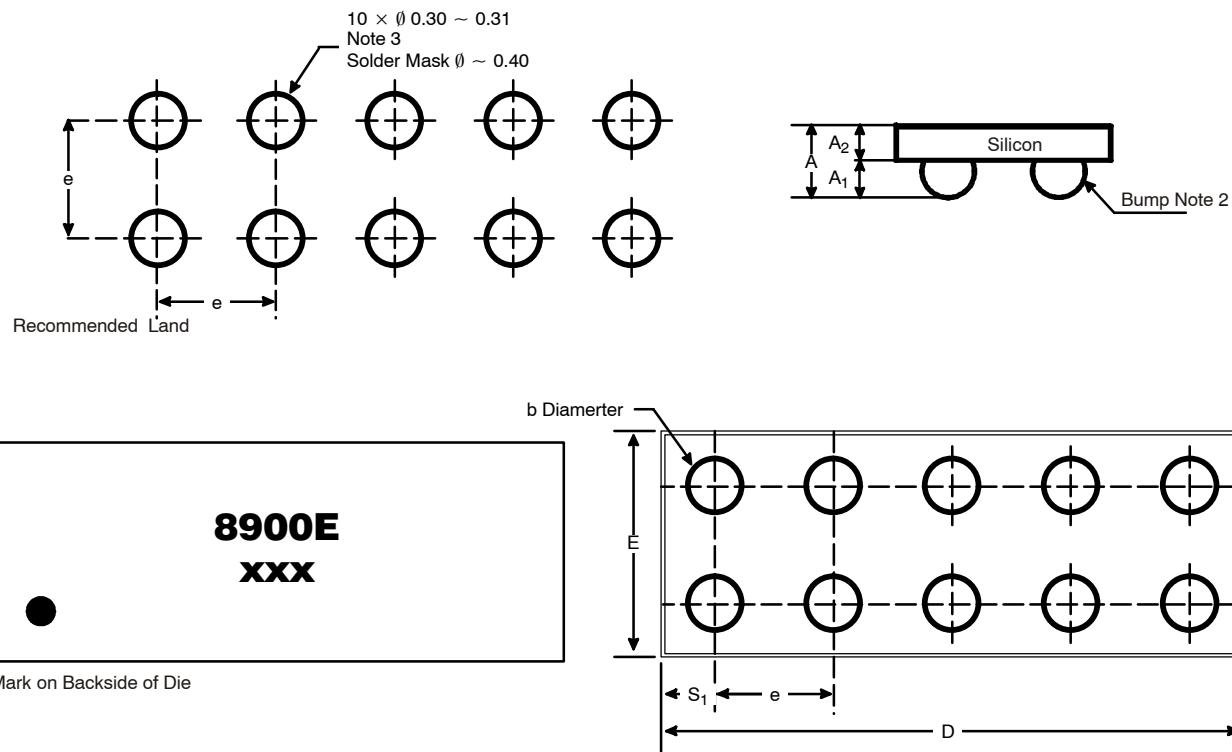
## Notes

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .  
 b. Guaranteed by design, not subject to production testing.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**


**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**
**Single Pulse Power, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Foot**


**PACKAGE OUTLINE**
**MICRO FOOT: 10-BUMP (2 X 5, 0.8-mm PITCH)**

**NOTES (Unless Otherwise Specified):**

1. Laser mark on the silicon die back, coated with a thin metal.
2. Bumps are Eutectic solder 63/57 Sn/Pb.
3. Non-solder mask defined copper landing pad.

Dim	<b>MILLIMETERS*</b>		<b>INCHES</b>	
	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>
<b>A</b>	0.600	0.650	0.0236	0.0256
<b>A<sub>1</sub></b>	0.260	0.290	0.102	0.0114
<b>A<sub>2</sub></b>	0.340	0.360	0.0134	0.0142
<b>b</b>	0.370	0.410	0.0146	0.0161
<b>D</b>	4.050	4.060	0.1594	0.1598
<b>E</b>	1.980	2.000	0.0780	0.0787
<b>e</b>	0.750	0.850	0.0295	0.0335
<b>s<sub>1</sub></b>	0.430	0.450	0.0169	0.0177
<b>s<sub>2</sub></b>	0.580	0.600	0.0228	0.0236

\* Use millimeters as the primary measurement.